



CMOS INTEGRATED CIRCUIT
μPD5713TK

WIDE BAND SPDT SWITCH

DESCRIPTION

The μPD5713TK is a CMOS MMIC for wide band SPDT (Single Pole Double Throw) switch which were developed for mobile communications, wireless communications and other general-purpose RF switching application.

This device can operate frequency from 0.05 to 2.5 GHz, having the low insertion loss and high isolation.

This device is housed in a 6-pin lead-less minimold (1511) package. And this package is able to high-density surface mounting.

FEATURES

- Supply voltage : $V_{DD} = 1.8$ to 3.6 V (2.8 V TYP.)
- Switch control voltage : $V_{cont(H)} = 1.8$ to 3.6 V (2.8 V TYP.)
: $V_{cont(L)} = -0.2$ to $+0.4$ V (0 V TYP.)
- Low insertion loss : $L_{ins1} = 0.6$ dB TYP. @ $f = 0.05$ to 1.0 GHz, $V_{DD} = 2.8$ V, $V_{cont(H)} = 2.8$ V, $V_{cont(L)} = 0$ V
: $L_{ins2} = 0.8$ dB TYP. @ $f = 1.0$ to 2.0 GHz, $V_{DD} = 2.8$ V, $V_{cont(H)} = 2.8$ V, $V_{cont(L)} = 0$ V
: $L_{ins3} = 0.95$ dB TYP. @ $f = 2.0$ to 2.5 GHz, $V_{DD} = 2.8$ V, $V_{cont(H)} = 2.8$ V, $V_{cont(L)} = 0$ V
- High isolation : $ISL1 = 32.5$ dB TYP. @ $f = 0.05$ to 1.0 GHz, $V_{DD} = 2.8$ V, $V_{cont(H)} = 2.8$ V, $V_{cont(L)} = 0$ V
: $ISL2 = 25$ dB TYP. @ $f = 1.0$ to 2.0 GHz, $V_{DD} = 2.8$ V, $V_{cont(H)} = 2.8$ V, $V_{cont(L)} = 0$ V
: $ISL3 = 22.5$ dB TYP. @ $f = 2.0$ to 2.5 GHz, $V_{DD} = 2.8$ V, $V_{cont(H)} = 2.8$ V, $V_{cont(L)} = 0$ V
- Handling power : $P_{in(1dB)} = +21.0$ dBm TYP. @ $f = 1.0$ GHz, $V_{DD} = 2.8$ V, $V_{cont(H)} = 2.8$ V, $V_{cont(L)} = 0$ V
: $P_{in(0.1dB)} = +17.0$ dBm TYP. @ $f = 1.0$ GHz, $V_{DD} = 2.8$ V, $V_{cont(H)} = 2.8$ V, $V_{cont(L)} = 0$ V
- High-density surface mounting : 6-pin lead-less minimold package ($1.5 \times 1.1 \times 0.55$ mm)

APPLICATIONS

- Mobile communications
- Wireless communications
- Another general-purpose RF switching applications

ORDERING INFORMATION

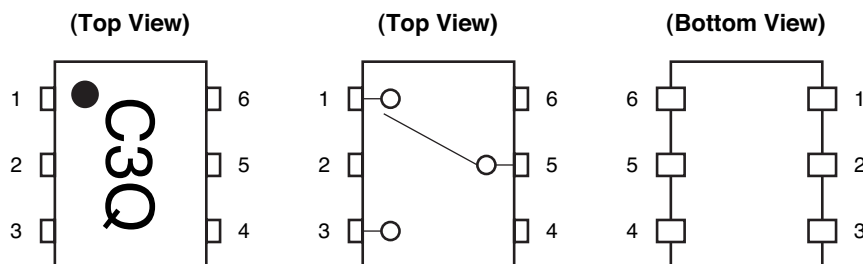
| Part Number | Order Number | Package | Marking | Supplying Form |
|--------------|----------------|---|---------|--|
| μPD5713TK-E2 | μPD5713TK-E2-A | 6-pin lead-less minimold (1511) (Pb-Free) | C3Q | <ul style="list-style-type: none"> • Embossed tape 8 mm wide • Pin 1, 6 face the perforation side of the tape • Qty 5 kpcs/reel |

Remark To order evaluation samples, contact your nearby sales office.
Part number for sample order: μPD5713TK-A

Caution Observe precautions when handling because these devices are sensitive to electrostatic discharge.

The information in this document is subject to change without notice. Before using this document, please confirm that this is the latest version.

PIN CONNECTIONS AND INTERNAL BLOCK DIAGRAM



| Pin No. | Pin Name |
|---------|-------------------|
| 1 | OUTPUT1 |
| 2 | GND |
| 3 | OUTPUT2 |
| 4 | V _{cont} |
| 5 | INPUT |
| 6 | V _{DD} |

TRUTH TABLE

| V _{cont} | INPUT-OUTPUT1 | INPUT-OUTPUT2 |
|-------------------|---------------|---------------|
| Low | OFF | ON |
| High | ON | OFF |

ABSOLUTE MAXIMUM RATINGS (T_A = +25°C, unless otherwise specified)

| Parameter | Symbol | Ratings | Unit |
|-------------------------------|--|--------------|------|
| Supply Voltage | V _{DD} | -0.5 to +4.6 | V |
| Switch Control Voltage | V _{cont} | -0.5 to +4.6 | V |
| Voltage Difference | V _{cont (H)} - V _{DD} | +0.5 | V |
| Input Power | P _{in} | +23 | dBm |
| Operating Ambient Temperature | T _A | -45 to +85 | °C |
| Storage Temperature | T _{stg} | -55 to +150 | °C |

RECOMMENDED OPERATING RANGE (T_A = +25°C, unless otherwise specified)

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|----------------------------|-----------------------|------|------|------|------|
| Supply Voltage | V _{DD} | +1.8 | +2.8 | +3.6 | V |
| Switch Control Voltage (H) | V _{cont (H)} | +1.8 | +2.8 | +3.6 | V |
| Switch Control Voltage (L) | V _{cont (L)} | -0.2 | 0 | +0.4 | V |

Remark V_{DD} - 0.4 V ≤ V_{cont (H)} ≤ V_{DD} + 0.2 V

ELECTRICAL CHARACTERISTICS

($T_A = +25^\circ\text{C}$, $V_{DD} = 2.8\text{ V}$, $V_{\text{cont(H)}} = 2.8\text{ V}$, $V_{\text{cont(L)}} = 0\text{ V}$, DC cut capacitors = 1 000 pF, unless otherwise specified)

| Parameter | Symbol | Test Conditions | MIN. | TYP. | MAX. | Unit |
|--|--------------------------|--|-------|-------|------|---------------|
| Insertion Loss 1 | L_{ins1} | $f = 0.05\text{ to }1.0\text{ GHz}$ | – | 0.6 | 0.8 | dB |
| Insertion Loss 2 | L_{ins2} | $f = 1.0\text{ to }2.0\text{ GHz}$ | – | 0.8 | 1.0 | dB |
| Insertion Loss 3 | L_{ins3} | $f = 2.0\text{ to }2.5\text{ GHz}$ | – | 0.95 | 1.2 | dB |
| Isolation 1 | ISL1 | $f = 0.05\text{ to }1.0\text{ GHz}$ | 30 | 32.5 | – | dB |
| Isolation 2 | ISL2 | $f = 1.0\text{ to }2.0\text{ GHz}$ | 22 | 25 | – | dB |
| Isolation 3 | ISL3 | $f = 2.0\text{ to }2.5\text{ GHz}$ | 20 | 22.5 | – | dB |
| Input Return Loss | RL_{in} | $f = 0.05\text{ to }2.5\text{ GHz}$ | 13 | 17 | – | dB |
| Output Return Loss | RL_{out} | $f = 0.05\text{ to }2.5\text{ GHz}$ | 13 | 17 | – | dB |
| 0.1 dB Loss Compression Input Power ^{Note 1} | $P_{\text{in (0.1 dB)}}$ | $f = 1.0\text{ GHz}$ | +13.0 | +17.0 | – | dBm |
| 1 dB Loss Compression Input Power ^{Note 2} | $P_{\text{in (1 dB)}}$ | $f = 1.0\text{ GHz}$ | – | +21.0 | – | dBm |
| Supply Current | I_{DD} | $V_{DD} = V_{\text{cont}} = 2.8\text{ V}$, RF off | – | 0.01 | 1.0 | μA |
| Switch Control Current | I_{cont} | $V_{DD} = V_{\text{cont}} = 2.8\text{ V}$, RF off | – | 0.01 | 1.0 | μA |
| Switch Control Speed | t_{sw} | $f = 1.0\text{ GHz}$ | – | 30 | 100 | ns |

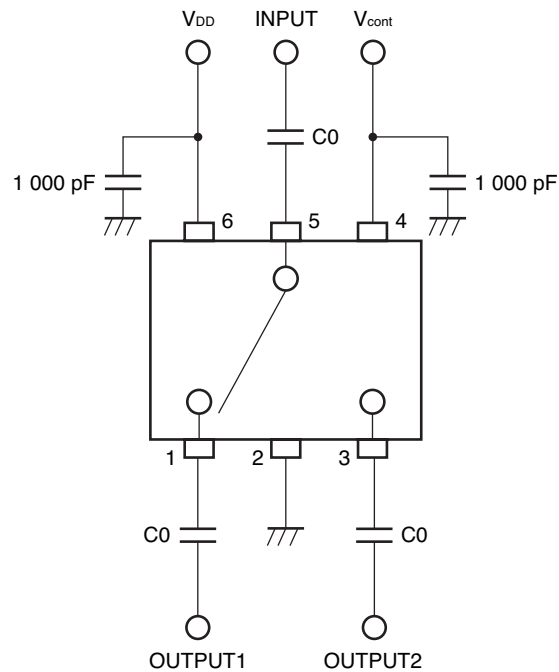
Notes 1. $P_{\text{in (0.1 dB)}}$ is measured the input power level when the insertion loss increases more 0.1 dB than that of linear range.

2. $P_{\text{in (1 dB)}}$ is measured the input power level when the insertion loss increases more 1 dB than that of linear range.

Caution It is necessary to use DC cut capacitors with this device.

The value of DC cut capacitors should be chosen to accommodate the frequency of operation, bandwidth, switching speed and the condition with actual board of your system.

EVALUATION CIRCUIT

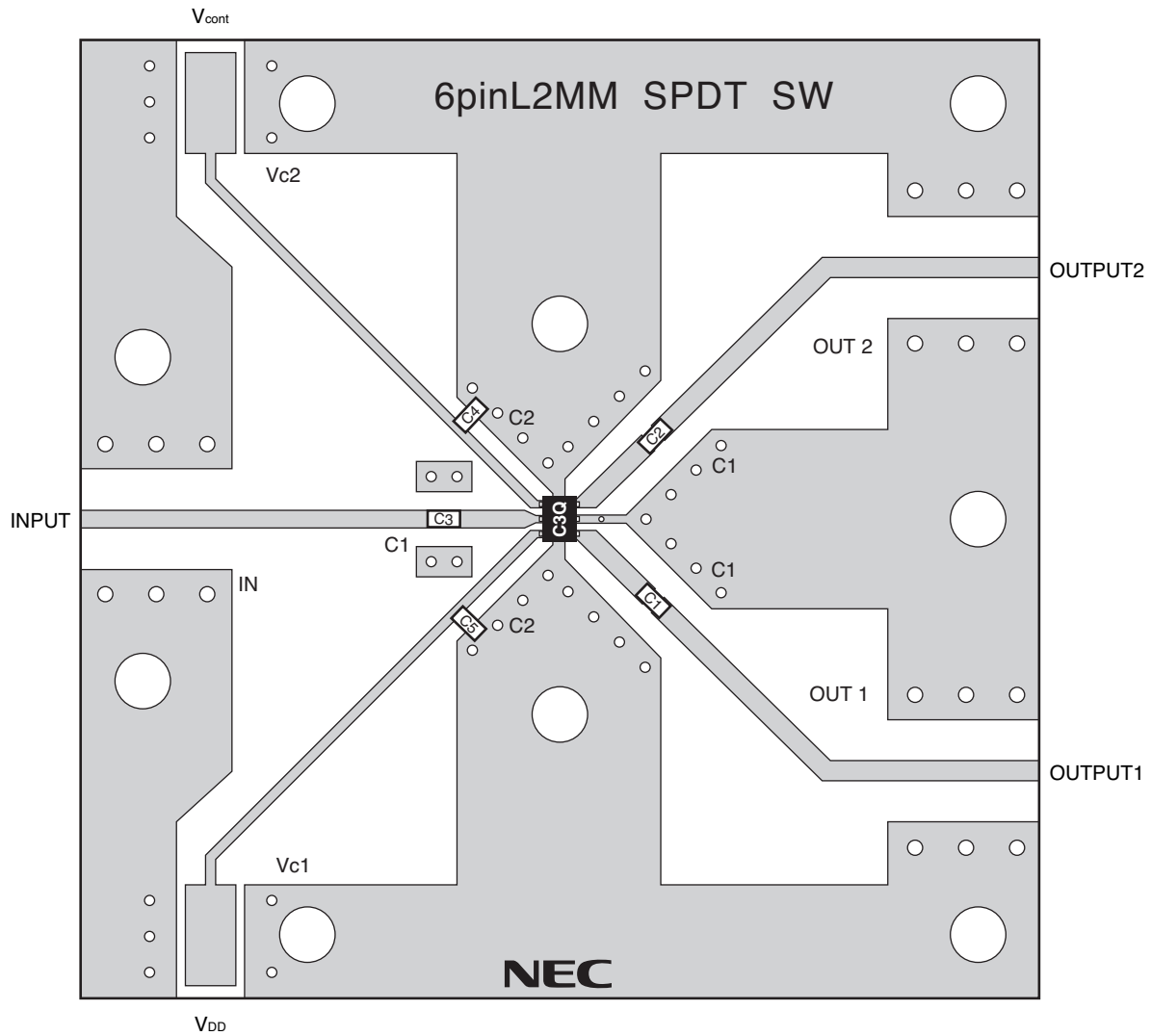


Remark $C0 = 1\ 000\ \text{pF}$

Caution This IC has pull down resistance between RF line and GND, which fixes electric potential of RF line to 0 V, then the IC cannot be used for DC switching.

The application circuits and their parameters are for reference only and are not intended for use in actual design-ins.

ILLUSTRATION OF THE TEST CIRCUIT ASSEMBLED ON EVALUATION BOARD

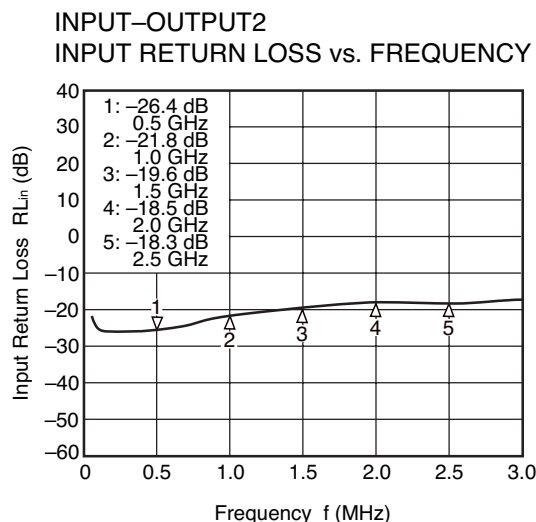
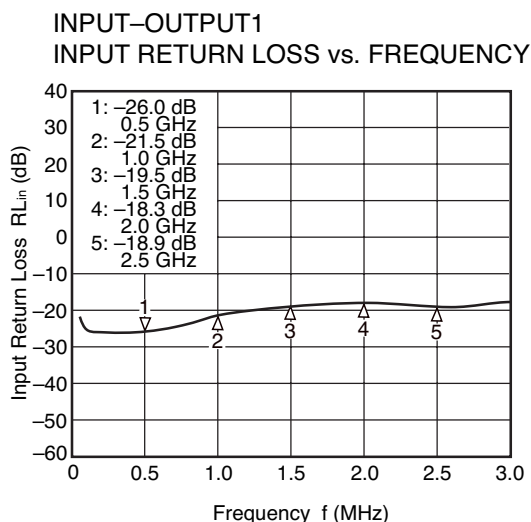
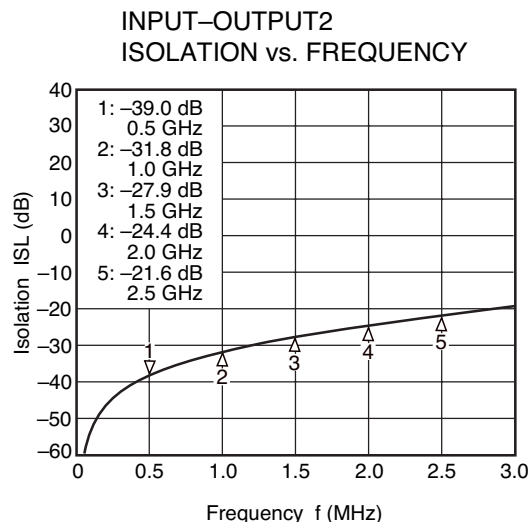
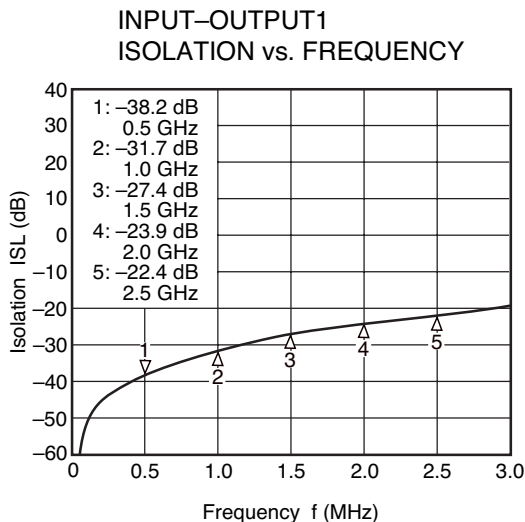
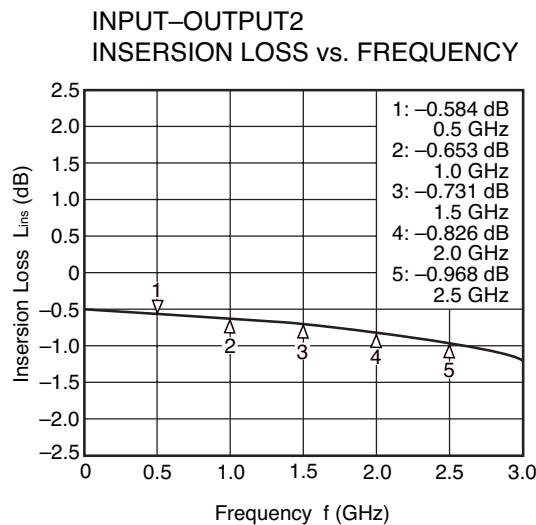
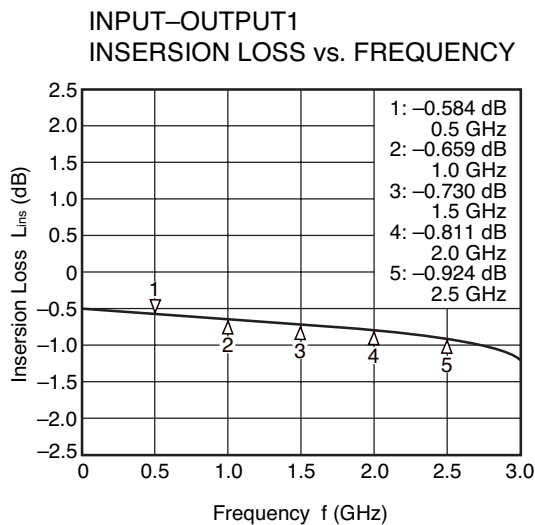


USING THE NEC EVALUATION BOARD

| Symbol | Values |
|------------|----------|
| C1, C2, C3 | 1 000 pF |
| C4, C5 | 1 000 pF |

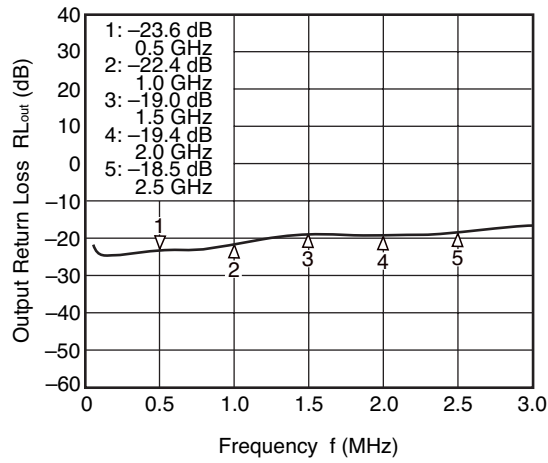
TYPICAL CHARACTERISTICS

($T_A = +25^\circ\text{C}$, $V_{DD} = 2.8\text{ V}$, $V_{\text{cont}}(\text{H}) = 2.8\text{ V}$, $V_{\text{cont}}(\text{L}) = 0\text{ V}$, $P_{\text{in}} = 0\text{ dBm}$, DC cut capacitors = 1 000 pF, unless otherwise specified)

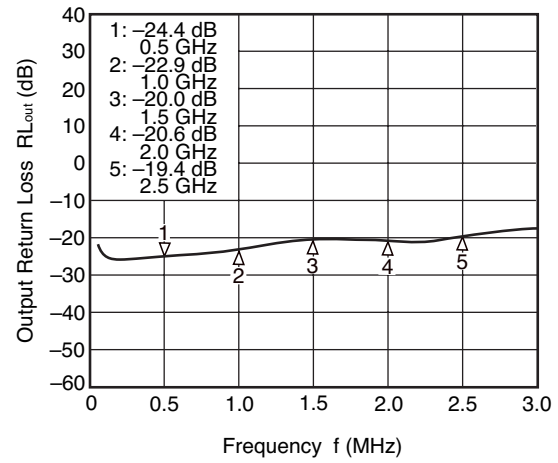


Remark The graphs indicate nominal characteristics.

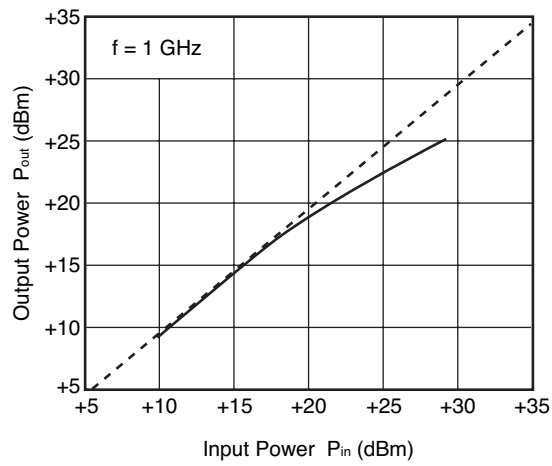
INPUT-OUTPUT1
OUTPUT RETURN LOSS vs. FREQUENCY



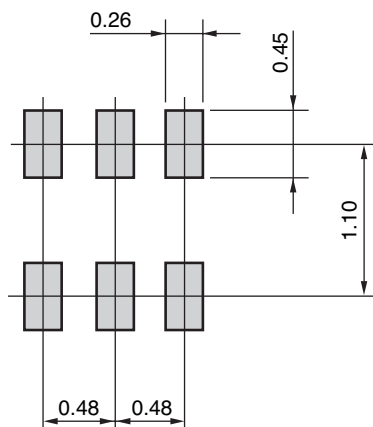
INPUT-OUTPUT2
OUTPUT RETURN LOSS vs. FREQUENCY



OUTPUT POWER vs. INPUT POWER



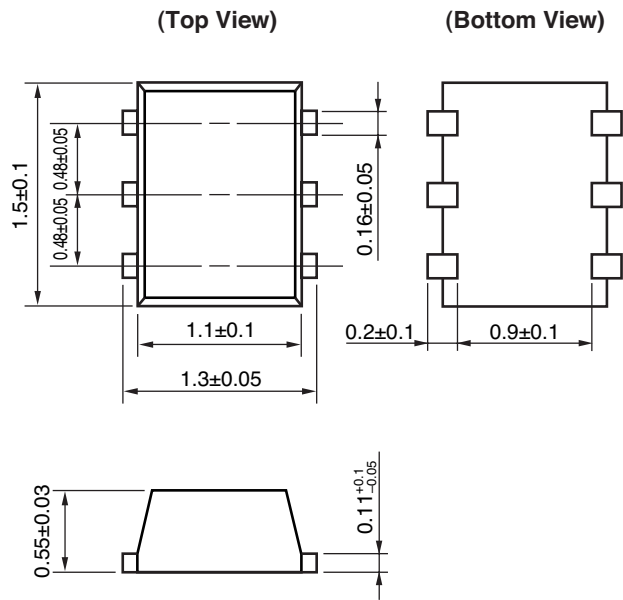
Remark The graphs indicate nominal characteristics.

MOUNTING PAD DIMENSIONS**6-PIN LEAD-LESS MINIMOLD (1511) (UNIT: mm)**

Remark The mounting pad layouts in this document are for reference only.

PACKAGE DIMENSIONS

6-PIN LEAD-LESS MINIMOLD (1511) (UNIT: mm)



RECOMMENDED SOLDERING CONDITIONS

This product should be soldered and mounted under the following recommended conditions. For soldering methods and conditions other than those recommended below, contact your nearby sales office.

| Soldering Method | Soldering Conditions | Condition Symbol |
|------------------|---|------------------|
| Infrared Reflow | Peak temperature (package surface temperature) : 260°C or below Time at peak temperature : 10 seconds or less Time at temperature of 220°C or higher : 60 seconds or less Preheating time at 120 to 180°C : 120±30 seconds Maximum number of reflow processes : 3 times Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below | IR260 |
| Wave Soldering | Peak temperature (molten solder temperature) : 260°C or below Time at peak temperature : 10 seconds or less Preheating temperature (package surface temperature) : 120°C or below Maximum number of flow processes : 1 time Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below | WS260 |
| Partial Heating | Peak temperature (terminal temperature) : 350°C or below Soldering time (per side of device) : 3 seconds or less Maximum chlorine content of rosin flux (% mass) : 0.2%(Wt.) or below | HS350 |

Caution Do not use different soldering methods together (except for partial heating).

Subject: Compliance with EU Directives

CEL certifies, to its knowledge, that semiconductor and laser products detailed below are compliant with the requirements of European Union (EU) Directive 2002/95/EC Restriction on Use of Hazardous Substances in electrical and electronic equipment (RoHS) and the requirements of EU Directive 2003/11/EC Restriction on Penta and Octa BDE.

CEL Pb-free products have the same base part number with a suffix added. The suffix –A indicates that the device is Pb-free. The –AZ suffix is used to designate devices containing Pb which are exempted from the requirement of RoHS directive (*). In all cases the devices have Pb-free terminals. All devices with these suffixes meet the requirements of the RoHS directive.

This status is based on CEL’s understanding of the EU Directives and knowledge of the materials that go into its products as of the date of disclosure of this information.

| Restricted Substance per RoHS | Concentration Limit per RoHS (values are not yet fixed) | Concentration contained in CEL devices | |
|-------------------------------|---|--|-----|
| | | -A | -AZ |
| Lead (Pb) | < 1000 PPM | Not Detected | (*) |
| Mercury | < 1000 PPM | Not Detected | |
| Cadmium | < 100 PPM | Not Detected | |
| Hexavalent Chromium | < 1000 PPM | Not Detected | |
| PBB | < 1000 PPM | Not Detected | |
| PBDE | < 1000 PPM | Not Detected | |

If you should have any additional questions regarding our devices and compliance to environmental standards, please do not hesitate to contact your local representative.

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